

XC7Z035-1FBG676C

XC7Z035-1FBG676C Information



Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.



XC7Z035-1FBG676C Specifications

Manufacturer Part Number	XC7Z035-1FBG676C
Manufacturer	Xilinx Inc.
Category	Integrated Circuits (ICs)
	Embedded - System On Chip (SoC)
Package	676-BBGA, FCBGA
Series	Zynq?-7000
Architecture	MCU, FPGA
Core Processor	Dual ARM? Cortex?-A9 MPCore? with CoreSight?
Flash Size	-
RAM Size	256KB
Peripherals	DMA
Connectivity	CAN, EBI/EMI, Ethernet, I2C, MMC/SD/SDIO, SPI, UART/USART, USB OTG
Speed	667MHz
Primary Attributes	Kintex?-7 FPGA, 275K Logic Cells
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	676-BBGA, FCBGA
Supplier Device Package	676-FCBGA (27x27)
	Report errors?

XC7Z035-1FBG676C Guarantees



Quality Guarantees

We provide 90 days warranty. * If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.

SERVICE BUARANTEE

Service Guarantees

We guarantee 100% customer satisfaction. Our experienced sales team and tech support team back our services to satisfy all our customers.

XC7Z035-1FBG676C Payment Methods



If you have any question about XC7Z035-1FBG676C, please do not hesitate to contact us! Website: https://www.heisener.com E-mail: salesdept@heisener.com